# Heat Spreader HSD Series

#### NEW



### Thin and flexible heat spreading sheet for superior thermal management



- Aluminum heat spreader material with excellent thermal conductivity (221 W/m·K)
- Spreads heat away from hot spots to cooler areas to prevent components from overheating
- Optional electrically insulating mylar (PET) layer can be applied upon request

210 x 510

• Ideal thermal solution for hot spots on space conscious applications such as mobile devices, tablets, routers, video streaming devices, etc.

#### Specification

Standard Sheet Size (mm

Part Number
Total Thickness ( mm )
Surface Thermal Conductivit
Peel Strength (N/25mm)
Flame Resistance
Operating Temperature (°C)

•	(The values below are not guaranteed)				
	Standard	HSD-0.07	HSD-0.22	HSD-0.30	
	_	0.07	0.22	0.30	
ty (W/m·K)	JIS R 2616 (hot-wire method)	221 (Aluminum)			
	JIS Z 0237:2009	>6	>16	>11	
	UL94	UL510 Equivalent			
	_	-20~100			

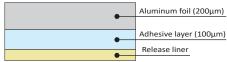
210 x 300

HSD-0.07 HSD-0.22 HSD-0.30

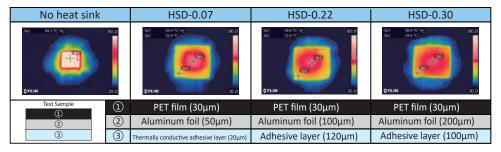
	•—	Aluminum foil (50µm) Thermally conductive adhesive layer (20µm)	
	_		
		Release liner	

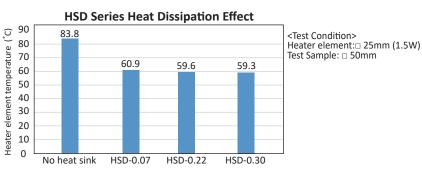
	Aluminum foil (100μm)
	Adhesive layer (120μm)
	Release liner
•	nerease mier

210 x 510



#### Heat dissipation effect ( heat distribution )





# Thermography Test sample Thermocouple Heater element Power source

**Testing method** 

## KGS America KITAGAWA INDUSTRIES America, Inc.

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Volume resistivity stated on our EMI absorber flyer is meant for noise control parameters, where the absorber is considered a conductor, but not for insulation performance. Care should be taken when using absorbers. KITAGAWA INDUSTRIES America, Inc. makes no guarantees as to electrical resistivity values and accepts no liability due to short circuits where EMI absorbers are used directly on a PC Board or areas near high voltage such as for power. The products are designed for EMI noise reduction for electronics. This is not recommended for applications involving human life or extremely high accuracy. Prior to using the products in producin, please verify their performance or adhesive strength of PSA for long term use. Avoid applying any external stress such as bending or high amounts of tension. Note when the absorber products are cut, bent, or pulled, there may be a possibility of creating cracks. For storage, keep products in a cool, dry, well-ventilated area at room temperature and avoid high temperatures, humidity, and direct sunlight.

Please contact the sales department at KITAGAWA INDUSTRIES America, Inc. for the use of our products prior to selecting the parts for